



20CTQ...SPbF 20CTQ...-1PbF

SCHOTTKY RECTIFIER

20 Amp

$I_{F(AV)} = 20\text{Amp}$
 $V_R = 35/ 45\text{V}$

Major Ratings and Characteristics


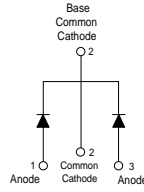

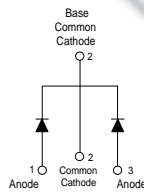
Characteristics	Values	Units
$I_{F(AV)}$ Rectangular waveform	20	A
V_{RRM} range	35/ 45	V
I_{FSM} @ tp = 5 μ s sine	1060	A
V_F @ 10 Apk, $T_J = 125^\circ\text{C}$ (per leg)	0.57	V
T_J range	-55 to 175	$^\circ\text{C}$

Description/ Features

The 20CTQ.. center tap Schottky rectifier series has been optimized for low reverse leakage at high temperature. The proprietary barrier technology allows for reliable operation up to 175° C junction temperature. Typical applications are in switching power supplies, converters, free-wheeling diodes, and reverse battery protection.

- 175° C T_J operation
- Center tap TO-220 package
- Low forward voltage drop
- High purity, high temperature epoxy encapsulation for enhanced mechanical strength and moisture resistance
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Lead-Free ("PbF" suffix)

Case Styles

<p>20CTQ...SPbF</p>   <p>D²PAK</p>	<p>20CTQ...-1PbF</p>   <p>TO-262</p>
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Voltage Ratings

Part number	20CTQ035SPbF 20CTQ035-1PbF	20CTQ040SPbF 20CTQ040-1PbF	20CTQ045SPbF 20CTQ045-1PbF
V_R Max. DC Reverse Voltage (V)	35	40	45
V_{RWM} Max. Working Peak Reverse Voltage (V)			

Absolute Maximum Ratings

Parameters	20CTQ	Units	Conditions
$I_{F(AV)}$ Max. Average Forward Current * See Fig. 5	20	A	50% duty cycle @ $T_C = 145^\circ\text{C}$, rectangular wave form
I_{FSM} Max. Peak One Cycle Non-Repetitive Surge Current (Per Leg) * See Fig. 7	1060	A	5 μs Sine or 3 μs Rect. pulse 10ms Sine or 6ms Rect. pulse
	265		
E_{AS} Non-Repetitive Avalanche Energy (Per Leg)	13	mJ	$T_J = 25^\circ\text{C}$, $I_{AS} = 2.0$ Amps, $L = 6.5$ mH
I_{AR} Repetitive Avalanche Current (Per Leg)	2.0	A	Current decaying linearly to zero in 1 μsec Frequency limited by T_J max. $V_A = 1.5 \times V_R$ typical

Electrical Specifications

Parameters	20CTQ	Units	Conditions
V_{FM} Max. Forward Voltage Drop (Per Leg) * See Fig. 1 (1)	0.64	V	@ 10A
	0.76	V	@ 20A
	0.57	V	@ 10A
	0.68	V	@ 20A
I_{RM} Max. Reverse Leakage Current (Per Leg) * See Fig. 2 (1)	2	mA	$T_J = 25^\circ\text{C}$
	15	mA	$T_J = 125^\circ\text{C}$
C_T Max. Junction Capacitance (Per Leg)	900	pF	$V_R = 5V_{DC}$ (test signal range 100Khz to 1Mhz) 25°C
L_S Typical Series Inductance (Per Leg)	8.0	nH	Measured lead to lead 5mm from package body
dv/dt Max. Voltage Rate of Change (Rated V_R)	10000	V/ μs	

(1) Pulse Width < 300 μs , Duty Cycle <2%

Thermal-Mechanical Specifications

Parameters	20CTQ	Units	Conditions
T_J Max. Junction Temperature Range	-55 to 175	$^\circ\text{C}$	
T_{stg} Max. Storage Temperature Range	-55 to 175	$^\circ\text{C}$	
R_{thJC} Max. Thermal Resistance Junction to Case (Per Leg)	3.25	$^\circ\text{C}/\text{W}$	DC operation * See Fig. 4
R_{thJC} Max. Thermal Resistance Junction to Case (Per Package)	1.63	$^\circ\text{C}/\text{W}$	DC operation
R_{thCS} Typical Thermal Resistance, Case to Heatsink	0.50	$^\circ\text{C}/\text{W}$	Mounting surface, smooth and greased
wt Approximate Weight	2(0.07)	g(oz.)	
T Mounting Torque	Min. 6(5)	Kg-cm (lbf-in)	
	Max. 12(10)		
Marking Device	20CTQ...S	Case style D ² Pak	
	20CTQ...-1	Case style TO-262	

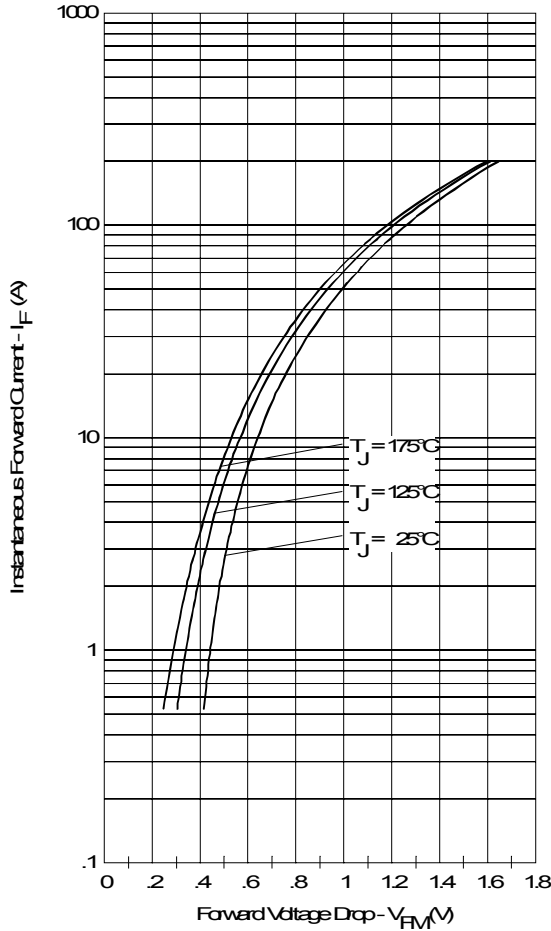


Fig. 1 - Max. Forward Voltage Drop Characteristics (Per Leg)

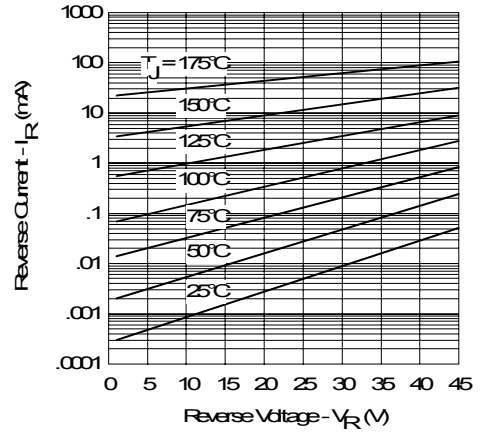


Fig. 2 - Typical Values Of Reverse Current Vs. Reverse Voltage (Per Leg)

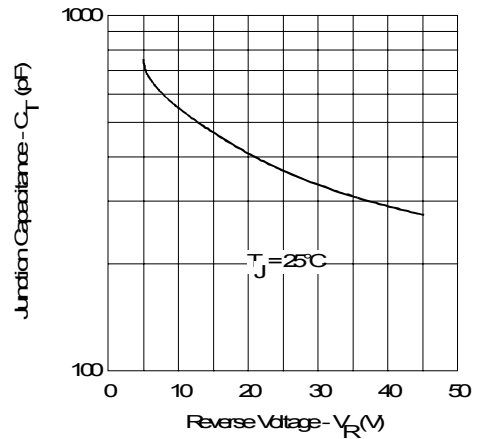


Fig. 3 - Typical Junction Capacitance Vs. Reverse Voltage (Per Leg)

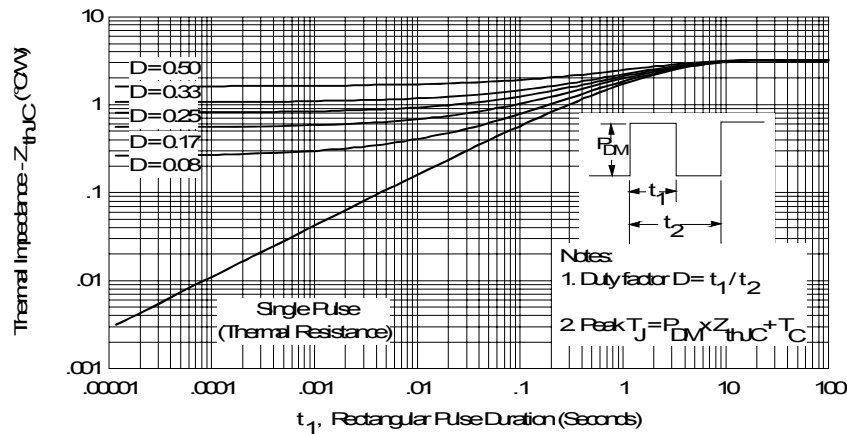


Fig. 4 - Max. Thermal Impedance Z_{thJC} Characteristics (Per Leg)

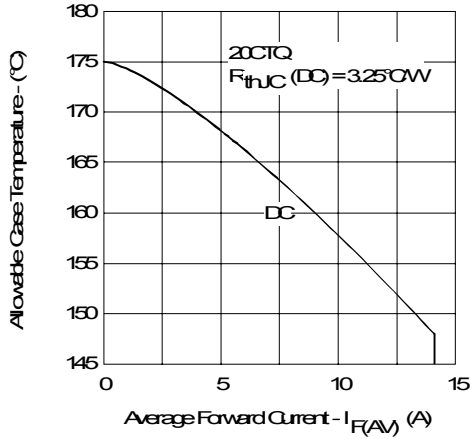


Fig. 5 - Max. Allowable Case Temperature Vs. Average Forward Current (Per Leg)

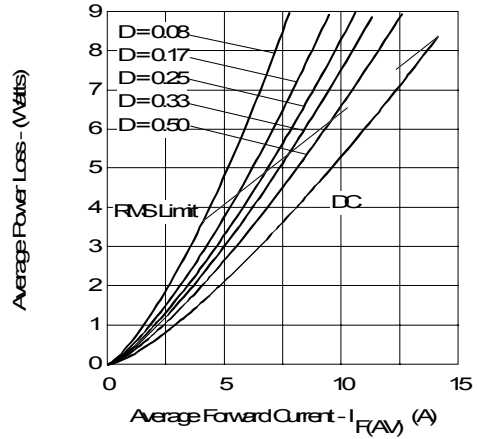


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

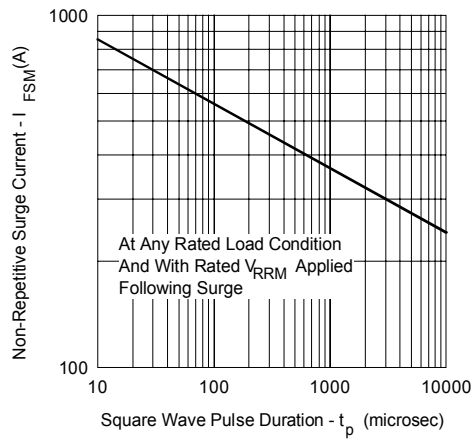


Fig. 7 - Max. Non-Repetitive Surge Current (Per Leg)

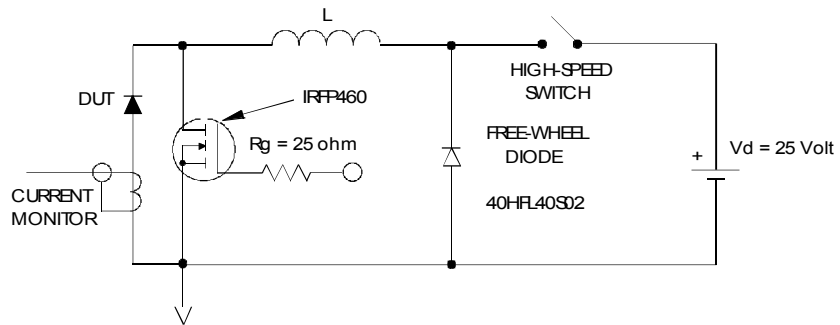


Fig. 8 - Unclamped Inductive Test Circuit

Outlines Table

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
 4. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
 5. CONTROLLING DIMENSIONS: INCH.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	4
A1	0.00	0.254	.000	.010	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	
b2	1.14	1.78	.045	.070	4
c	0.38	0.74	.015	.029	
c1	0.38	0.58	.015	.023	3
c2	1.14	1.65	.045	.065	
D	8.51	9.65	.335	.380	3
D1	6.86	—	.270	—	
E	9.65	10.67	.380	.420	3
E1	6.22	—	.245	—	
e	2.54 BSC		.100 BSC		4
H	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
L1	—	1.65	—	.065	
L2	1.27	1.78	.050	.070	4
L3	0.25 BSC		.010 BSC		
L4	4.78	5.28	.188	.208	4
m	17.78	—	.700	—	
m1	8.89	—	.350	—	
n	11.43	—	.450	—	
o	2.08	—	.082	—	
p	3.81	—	.150	—	
R	0.51	0.71	.020	.028	4
θ	90°	93°	90°	93°	

LEAD ASSIGNMENTS
 HEXFEET
 1.- GATE
 2, 4.- DRAIN
 3.- SOURCE

IGBTs, CoPACK
 1.- GATE
 2, 4.- COLLECTOR
 3.- EMITTER

DIODES
 1.- ANODE *
 2, 4.- CATHODE
 3.- ANODE

* PART DEPENDENT.

Conform to JEDEC outline D²Pak (SMD-220)
 Dimensions in millimeters and (inches)

NOTES:
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994
 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
 3. DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 [0.005"] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
 4. THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
 5. DIMENSION b1 AND c1 APPLY TO BASE METAL ONLY.
 6. CONTROLLING DIMENSION: INCH.
 7.- OUTLINE CONFORM TO JEDEC TO-262 EXCEPT A1(max.), b(min.) AND D1(min.) WHERE DIMENSIONS DERIVED THE ACTUAL PACKAGE OUTLINE.

SYMBOL	DIMENSIONS				NOTES
	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	.160	.190	5
A1	2.03	3.02	.080	.119	
b	0.51	0.99	.020	.039	
b1	0.51	0.89	.020	.035	
b2	1.14	1.78	.045	.070	5
b3	1.14	1.73	.045	.068	
c	0.38	0.74	.015	.029	5
c1	0.38	0.58	.015	.023	
c2	1.14	1.65	.045	.065	3
D	8.58	9.65	.330	.380	
D1	6.86	—	.270	—	4
E	9.65	10.67	.380	.420	
E1	6.22	—	.245	—	4
e	2.54 BSC		.100 BSC		
L	13.46	14.10	.530	.555	4
L1	—	1.65	—	.065	
L2	3.56	3.71	.140	.146	

LEAD ASSIGNMENTS
 HEXFEET
 1.- GATE
 2.- DRAIN
 3.- SOURCE
 4.- DRAIN

IGBTs, CoPACK
 1.- GATE
 2.- COLLECTOR
 3.- EMITTER
 4.- COLLECTOR

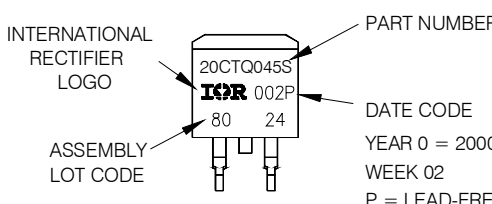
Modified JEDEC outline TO-262
 Dimensions in millimeters and (inches)

Part Marking Information

D²PAK

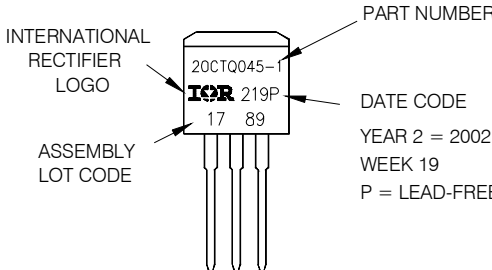
EXAMPLE: THIS IS A 20CTQ045S
 LOT CODE 8024
 ASSEMBLED ON WW 02, 2000

Note: "P" in assembly line position indicates "Lead-Free"

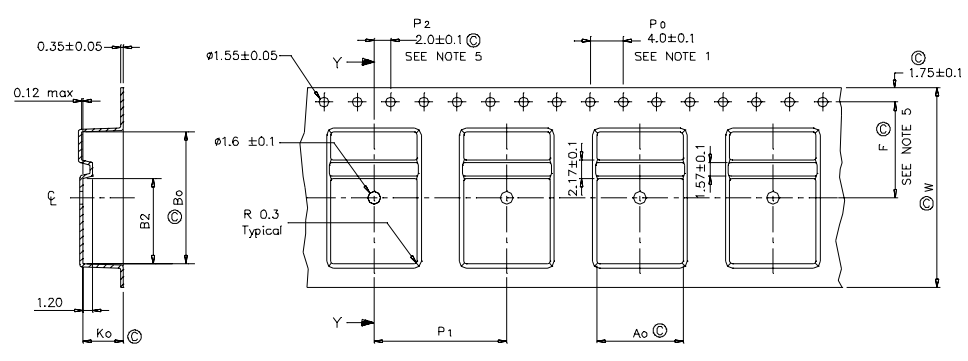


EXAMPLE: THIS IS A 20CTQ045-1
 LOT CODE 1789
 ASSEMBLED ON WW 19, 2002

Note: "P" in assembly line position indicates "Lead-Free"



Tape & Reel Information



SECTION Y-Y

NOTES:

- 1.0 10 SPROCKET HOLE PITH CUMULATIVE TOLERANCE ±.02
- 2.0 CAMBER NOT TO EXCEED 1mm In 100mm
- 3.0 MATERIAL: CONDUCTIVE BLACK STYRENIC ALLOY
- 4.0 Ko MEASURED FROM A PLANE ON THE INSIDE BOTTOM OF THE POCKET TO THE TOP SURFACE OF THE CARRIER
- 5.0 MEASURED FROM CENTRELINE OF SPROCKET HOLE TO CENTRELINE OF POCKET
- 6.0 VENDOR: (OPTIONAL)
- 7.0 MUST ALSO MEET REQUIREMENTS OF EIA STANDAR #EIA-481A TAPING OF SURFACE MOUNT COMPONENTS FOR AUTOMATIC PLACEMENT
- 8.0 SURFACE RESISTIVITY OF MOLDED MATL. MUST MEASURE LESS OR EQUAL TO 10⁶ OHMS PER SQUARE. MEASURED IN ACCORDANCE TO PROCEDURE GIVEN IN ASTM D-257 & ASTM D-991
- 9.0 TOTAL LENGTH PER REEL MUST BE 45 METERS
- 10.0 © CRITICAL

Ao	10.50 +/- 0.1
Bo	15.80 +/- 0.1
B2	10.25 +/- 0.1
Ko	4.90 +/- 0.1
F	11.50 +/- 0.1
P1	16.00 +/- 0.1
W	24.00 +/- 0.3

Dimensions in millimeters and (inches)

Ordering Information Table

Device Code							
1	2	3	4	5	6	7	8
20	C	T	Q	045	S	TRL	PbF
1	-	Current Rating (20A)					
2	-	Circuit Configuration					
		C = Common Cathode					
3	-	T = TO-220					
4	-	Schottky "Q" Series					
5	-	Voltage Ratings					
6	-	• S = D ² Pak					
		• -1= TO-262					
7	-	• none = Tube (50 pieces)					
		• TRL = Tape & Reel (Left Oriented - for D ² Pak only)					
		• TRR = Tape & Reel (Right Oriented - for D ² Pak only)					
8	-	• none = Standard Production					
		• PbF = Lead-Free					

Data and specifications subject to change without notice.
 This product has been designed and qualified for Industrial Level and Lead-Free.
 Qualification Standards can be found on IR's Web site.



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